## 505845163 01/03/2020

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

NEW ACCIONATE

EPAS ID: PAT5892099

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
CHI-HSUN LEE	01/02/2020
HSIEH-SHEN HSIEH	01/02/2020
SEN-HUEI CHEN	01/02/2020

#### **RECEIVING PARTY DATA**

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Internal Address:	SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16732342

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	6101.179US	
NAME OF SUBMITTER:	MIN-LEE TENG	
SIGNATURE:	/Min-Lee Teng/	
DATE SIGNED:	01/03/2020	

**Total Attachments: 2** 

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PATENT 505845163 REEL: 051406 FRAME: 0055

# ASSIGNMENT (PATENT APPLICATION)

WHEREAS, we, ("ASSIGNORS"):

<u>Inventor</u>	Citizenship	Address
CHI-HSUN LEE	Taiwan, R. O. C.	4F., No.88, Dehui St., Zhongshan Dist., Taipei City 10471, Taiwan (R.O.C.)
HSIEH-SHEN HSIEH	Taiwan, R. O. C.	No.213, Xi' an Rd., Hemei Township, Changhua
		County 50853, Taiwan (R.O.C.)
SEN-HUEI CHEN	Taiwan, R. O. C.	No.10-2, Ln. 47, Zhongyang Rd., Tuku Township,
		Yunlin County 63342, Taiwan (R.O.C.)

having invented a certain new and useful invention entitled:

### AN INDUCTOR WITH AN ELECTRODE STRUCTURE

for which a United States patent application is to be filed or has been filed on <u>Jan. 1, 2020</u> under U.S. Patent Application No. <u>16/732,342</u>; and

WHEREAS, ("ASSIGNEE"):

CYNTEC CO., LTD.
NO. 2, RESEARCH & DEVELOPMENT 2ND RD.
SCIENCE PARK, HSINCHU
TAIWAN, R.O.C.

is desirous of acquiring the entire right, title and interest in and to the invention throughout the United States and the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all countries throughout the world;

FOR GOOD and VALUABLE CONSIDERATION, the full receipt and sufficiency of which are hereby acknowledged, ASSIGNORS, intending to be legally bound, do hereby:

AUTHORIZE said ASSIGNEE, or its representatives to insert above the filing date and application number of the application when these are known;

SELL, ASSIGN, TRANSFER and CONVEY to ASSIGNEE the whole and entire right, title and interest for the United States and its possessions and territories and all foreign countries in and to the invention which is disclosed in the above-identified patent application, and, in and to any and all patent applications related thereto including, but not limited to, all provisionals, non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues and all other applications for patent which have been or shall be filed in the United States and all foreign countries on the invention; all original, reissued and reexamined patents and extensions thereof which have been or shall be issued in the United States and all foreign countries on the invention to the full end of the term or terms for which the patent(s) may be granted, as fully and entirely as the same would have been held by the undersigned

ASSIGNOR(S) had this Assignment not been made; and specifically including all rights of priority created by the above patent application under any treaty, convention or law relating thereto;

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RECORDED: 01/03/2020

AUTHORIZE and REQUEST the issuing authority to issue any and all United States and foreign patents granted on the invention to ASSIGNEE;

WARRANT and REPRESENT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by ASSIGNORS, and that the full right to convey the same as herein expressed is possessed by ASSIGNORS;

AGREE and UNDERTAKE, when requested and at the expense of ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, ASSIGNORS will execute all nonprovisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues, and all other patent applications on the invention; execute all lawful oaths, declarations, assignments, powers of attorney and other papers; communicate to ASSIGNEE all facts known to ASSIGNORS relating to the invention and the history thereof; and generally do everything possible which ASSIGNEE shall consider desirable for vesting title to the invention in ASSIGNEE, and for securing, maintaining and enforcing proper patent protection for the invention; all without further compensation to ASSIGNORS;

AGREES to hold in trust, keep confidential, not make use of, and not disclose or reveal to any third party said invention, without ASSIGNEE'S prior written consent.

TO BE BINDING on the heirs, assigns, representatives and successors of ASSIGNORS and extending to the successors, assigns, and nominees of ASSIGNEE.

01/02/2020	/ CHI-HSUN LEE /
Date	CHI-HSUN LEE
01/02/2020	/ HSIEH-SHEN HSIEH /
Date	HSIEH-SHEN HSIEH
01/02/2020	/ SEN-HUEI CHEN /
Date	SEN-HUEI CHEN

**PATENT** REEL: 051406 FRAME: 0057